

Docket No. 240245US90CONT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Yasuji HIRAMATSU, et al.

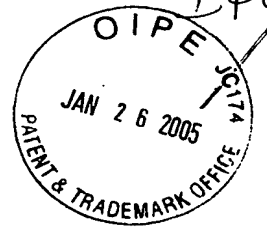
SERIAL NO: 10/619,567

GAU: 2822

FILED: July 16, 2003

EXAMINER: ROSE, KIESHA L.

FOR: CERAMIC SUBSTRATE



INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

Applicant(s) wish to disclose the following information.

REFERENCES

- ☐ The applicant(s) wish to make of record the references listed on the attached form PTO-1449. Copies of the listed references are attached, where required, as are either statements of relevancy or any readily available English translations of pertinent portions of any non-English language references.
- ☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

RELATED CASES

- ☒ Attached is a list of applicant's pending application(s), published application(s) or issued patent(s) which may be related to the present application. In accordance with the waiver of 37 CFR 1.98 dated September 21, 2004, copies of the cited pending applications are not provided. Cited published and/or issued patents, if any, are listed on the attached PTO form 1449.
- ☒ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

CERTIFICATION

- ☐ Each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.
- ☐ No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

DEPOSIT ACCOUNT

- ☒ Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number 15-0030. A duplicate copy of this sheet is enclosed.

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Respectfully submitted,

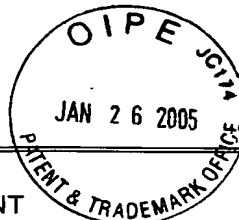
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Form PTO 1449 (Modified)		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		ATTY DOCKET NO. 240245US90CONT		SERIAL NO. 10/619,567	
LIST OF REFERENCES CITED BY APPLICANT				APPLICANT Yasuji HIRAMATSU, et al.			
				FILING DATE July 16, 2003		GROUP 2822	
U.S. PATENT DOCUMENTS							
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
	AA	2003/0203225	10/30/03	HIRAMATSU et al.			
	AB	2004/0007773	01/15/04	HIRAMATSU et al.			
	AC	2004/0011782	01/22/04	ITO et al.			
	AD	2004/0011781	01/22/04	ITO et al.			
	AE	2004/0016746	01/29/04	ITO et al.			
	AF	2004/0142153	07/22/04	NIWA			
	AG	2004/0045951	03/11/04	ITO et al.			
	AH	2004/0060920	04/01/04	ITO et al.			
	AI	2004/0099708	05/27/04	HIRAMATSU et al.			
	AJ						
	AK						
	AL						
	AM						
	AN						
FOREIGN PATENT DOCUMENTS							
		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION YES NO		
	AO						
	AP						
	AQ						
	AR						
	AS						
	AT						
	AU						
	AV						
OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)							
	AW						
	AX						
	AY						
	AZ					<input type="checkbox"/> Additional References sheet(s) attached	
Examiner					Date Considered		
*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.							



LIST OF RELATED CASES

<u>Docket Number</u>	<u>Serial or Patent Number</u>	<u>Filing or Issue Date</u>	<u>Patent Appl. Publication No.</u>	<u>Inventor/ Applicant</u>
237250US90 CONT	10/442,967	05/22/03	2003/0203225	HIRAMATSU et al.
237457US90 CONT	10/615,950	07/10/03	2004/0007773	HIRAMATSU et al.
238745US90 CONT	10/618,651	07/15/03	2004/0011782	ITO et al.
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240245US90 CONT*	10/619,567	07/16/03	2004/0084762	HIRAMATSU et al.
241191US90 CONT	10/670,354	09/26/03	2004/0142153	NIWA
242402US90 CONT	10/658,454	09/10/03	2004/0045951	ITO et al.
243468US90 PCT	10/473,585	02/13/04		ITO
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256575US90 CONT	10/918,351	08/16/04		ITO et al.
257055US90 CONT	10/916,405	08/12/04		HIRAMATSU et al.
257463US90 CONT	10/921,992	08/20/04		HIRAMATSU et al.
257487US90 CONT	10/921,271	08/19/04		HIRAMATSU et al.
257965US90 CONT	10/928,146	08/30/04		HIRAMATSU et al.

*Present Application; listed for information

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